

### GENERAL DESCRIPTION

The SGM6610 is a high-efficient synchronous boost converter. The 2.7V to 12V operation input voltage is suitable for single-cell or two-cell Li-Ion batteries. This device is capable to provide 10A switch current and an output voltage range of 4.5V to 12.6V. The SGM6610 has two operation modes, the pulse width modulation (PWM) mode and pulse frequency modulation (PFM). The PWM mode is applied at moderate to heavy loads. The PFM mode is applied at light load to improve the efficiency. An adjustable switching frequency of 200kHz to 2.2MHz can be operated in the PWM mode. The protection features include output over-voltage protection at 13.2V, cycle-by-cycle over-current protection and thermal shutdown. The device also involves the functions of programmable soft-start and adjustable switch peak current limit.

The SGM6610 is available in a Green TQFN-4.5×3.5-20L package. It operates over an ambient temperature range of -40°C to +85°C.

### FEATURES

- **2.7V to 12V Input Voltage Range**
- **4.5V to 12.6V Output Voltage Range**
- **10A Switch Current**
- **91% Peak Efficiency**  
( $V_{IN} = 3.3V$ ,  $V_{OUT} = 9V$ , and  $I_{OUT} = 3A$ )
- **0.5μA Current into VIN Pin in Shutdown**
- **200kHz to 2.2MHz Adjustable Switching Frequency**
- **Adjustable Switch Peak Current Limit**
- **Programmable Soft-Start**
- **PFM Mode at Light Load**
- **13.2V Over-Voltage Protection**
- **Cycle-by-Cycle Over-Current Protection**
- **Thermal Shutdown**
- **Available in a Green TQFN-4.5×3.5-20L Package**

### APPLICATIONS

Portable POS  
Bluetooth Speaker  
E-Cigarette  
Fast-Charging Power Bank

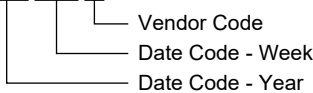
**PACKAGE/ORDERING INFORMATION**

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM6610	TQFN-4.5x3.5-20L	-40°C to +85°C	SGM6610YTQS20G/TR	SGM6610 YTQS20 XXXXX	Tape and Reel, 4000

**MARKING INFORMATION**

NOTE: XXXXX = Date Code and Vendor Code.

**XXXXX**



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

**ABSOLUTE MAXIMUM RATINGS**

- BOOT Voltage ..... -0.3V to  $V_{SW} + 6V$
- VIN, SW, VOUT Voltages ..... -0.3V to 14.5V
- EN, VCC, FSW, SS, COMP Voltages ..... -0.3V to 6V
- ILIM, FB Voltages ..... -0.3V to 6V
- Junction Temperature ..... +150°C
- Storage Temperature Range ..... -65°C to +150°C
- Lead Temperature (Soldering, 10s) ..... +260°C
- ESD Susceptibility
- HBM ..... 2000V
- MM ..... 400V
- CDM ..... 1000V

**RECOMMENDED OPERATING CONDITIONS**

- Inductance, Effective Value, L ..... 0.22µH to 4.7µH
- Input Capacitance, Effective Value,  $C_{IN}$  ..... 10µF (MIN)
- Output Capacitance, Effective Value,  $C_{OUT}$  .. 6.8µF to 1000µF
- Input Voltage Range ..... 2.7V to 12V
- Output Voltage Range ..... 4.5V to 12.6V
- Operating Ambient Temperature Range ..... -40°C to +85°C
- Operating Junction Temperature Range ..... -40°C to +125°C

**OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

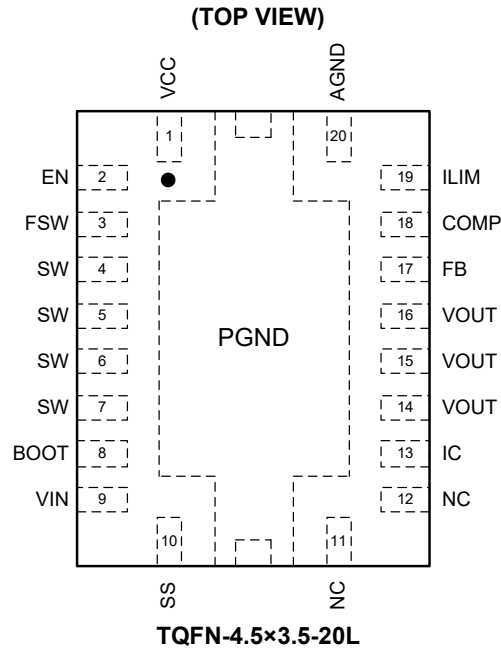
**ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

**DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

## PIN CONFIGURATION



## PIN DESCRIPTION

PIN	NAME	I/O	FUNCTION
1	VCC	O	Output of the Internal Regulator. The VCC pin connects a ceramic capacitor (> 1.0 $\mu$ F) to ground.
2	EN	I	Enable Logic Input. Logic high makes the circuit enabled, and logic low makes it disabled and the device enters shutdown mode.
3	FSW	I	Put a resistor between this pin and the AGND pin to program the switching frequency.
4, 5, 6, 7	SW	I	Switching Node Pin of the Converter. Connect to the drain of the internal low-side power MOSFET and source of the internal high-side power MOSFET.
8	BOOT	O	Power Supply for High-side MOSFET Gate Driver. Strongly recommend to apply a ceramic capacitor of 0.1 $\mu$ F between this pin and SW pin.
9	VIN	I	IC Power Supply Input.
10	SS	O	Soft-Start Programming Pin.
11, 12	NC	–	No Connection inside the Device. To achieve good thermal dissipation, connect the NC pins to ground plane on the PCB.
13	IC	I	Internal Connection. Leave it floating or connect to VCC.
14, 15, 16	VOUT	O	Boost Converter Output.
17	FB	I	Output Voltage Feedback. An external resistor divider programs the output voltage.
18	COMP	O	Output of the Internal Error Amplifier. Connect a loop compensation network between COMP and the AGND.
19	ILIM	O	Adjustable Switch Peak Current Limit. Connect an external resistor between this pin and the AGND.
20	AGND	–	Signal Ground of the IC.
Exposed Pad	PGND	–	Power Ground of the IC. Connect to the source of the low-side MOSFET.

NOTE: I = input, O = output.

## ELECTRICAL CHARACTERISTICS

(Minimum and maximum values are at  $V_{IN} = 2.7V$  to  $5.5V$  and Full =  $-40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $V_{IN} = 3.6V$  and  $T_A = +25^{\circ}C$ .  $L = 1.2\mu H$ ,  $C_{OUT} = 47\mu F$ , unless otherwise specified noted.)

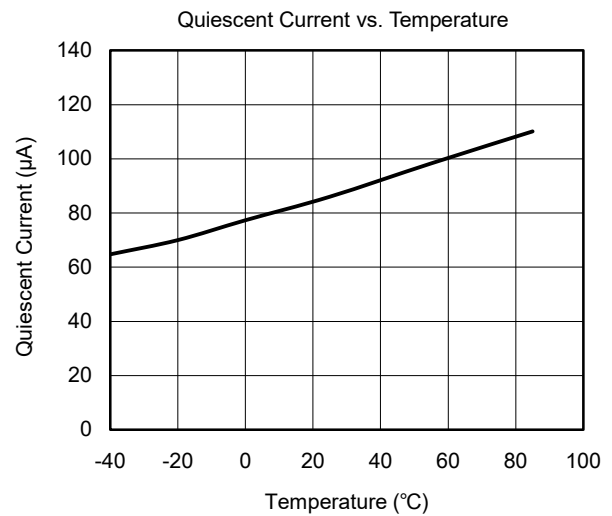
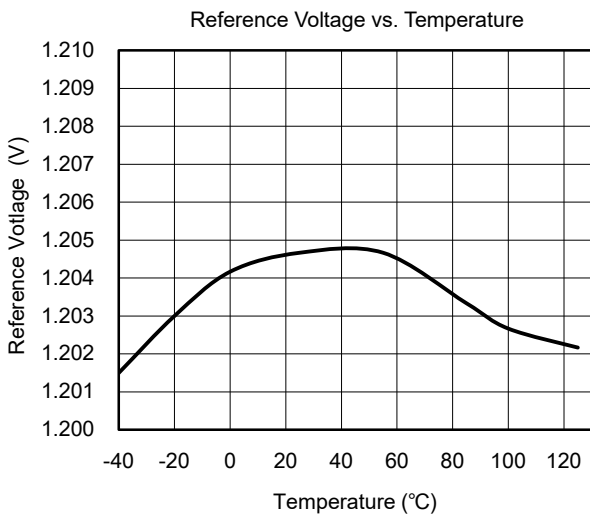
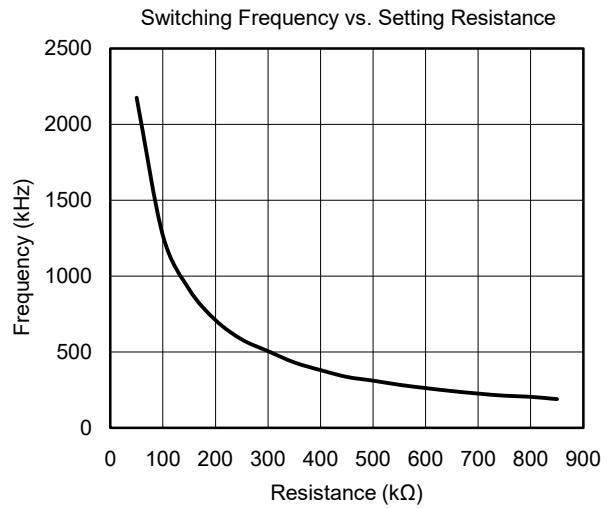
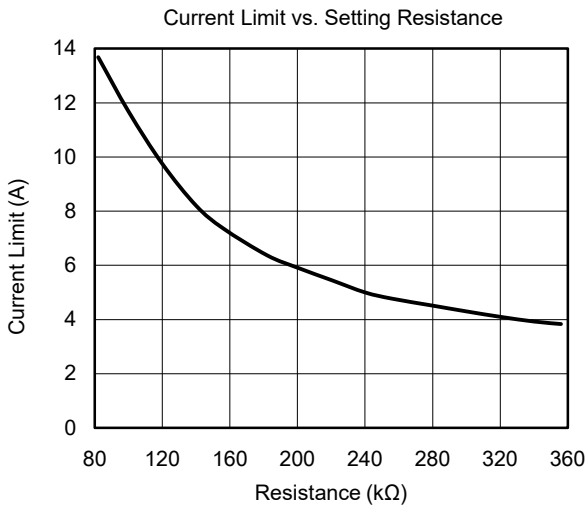
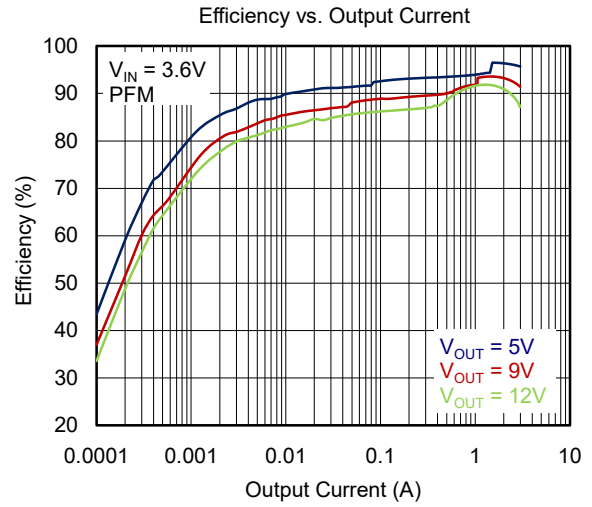
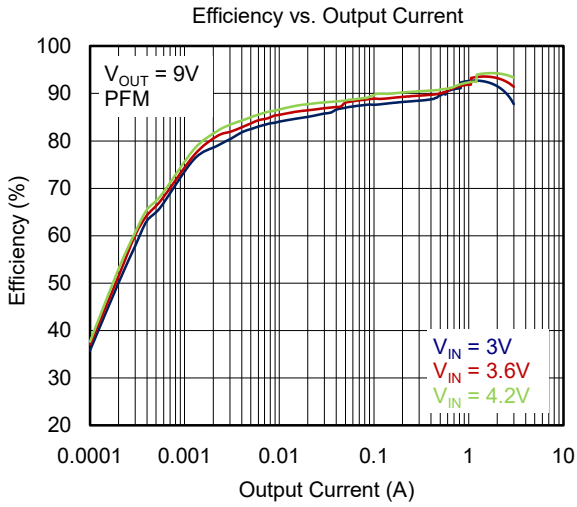
PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
<b>Power Supply</b>								
Input Voltage Range	$V_{IN}$		Full	2.7		12	V	
VIN Under-Voltage Lockout Threshold	$V_{IN\_UVLO}$	$V_{IN}$ rising	$+25^{\circ}C$		2.5	2.65	V	
		$V_{IN}$ falling	$+25^{\circ}C$		2.4			
VIN Under-Voltage Lockout Hysteresis	$V_{IN\_HYS}$		$+25^{\circ}C$		100		mV	
VCC Under-Voltage Lockout Threshold	$V_{CC\_UVLO}$	$V_{CC}$ falling	$+25^{\circ}C$		2.1		V	
Operating Quiescent Current	VIN Pin	$I_Q$	$+25^{\circ}C$		IC enabled, $V_{EN} = 2V$ , no load, $R_{ILIM} = 100k\Omega$ , $V_{FB} = 1.23V$ , $V_{OUT} = 12V$	0.22	0.4	$\mu A$
	VOOUT Pin					80	130	
Shutdown Current into the VIN Pin	$I_{SHDN}$	IC disabled, $V_{EN} = 0V$ , no load, no feedback resistor divider connected to the VOOUT pin	$+25^{\circ}C$		0.5	1.2	$\mu A$	
VCC Regulation	$V_{CC}$	$I_{VCC} = 5mA$ , $V_{IN} = 8V$	$+25^{\circ}C$		5		V	
<b>EN Input</b>								
EN High Threshold Voltage	$V_{ENH}$	$V_{CC} = 5V$	Full	1.3			V	
EN Low Threshold Voltage	$V_{ENL}$	$V_{CC} = 5V$	Full			0.4	V	
EN Internal Pull-Down Resistance	$R_{EN}$	$V_{CC} = 5V$	$+25^{\circ}C$		800		k $\Omega$	
<b>Output</b>								
Output Voltage Range	$V_{OUT}$		Full	4.5		12.6	V	
Reference Voltage at the FB Pin	$V_{REF}$	PWM mode	Full	1.180	1.204	1.234	V	
		PFM mode	$+25^{\circ}C$		1.206			
FB Pin Leakage Current	$I_{LKG\_FB}$	$V_{FB} = 1.2V$	$+25^{\circ}C$			0.1	$\mu A$	
Soft-Start Charging Current	$I_{SS}$		$+25^{\circ}C$		4		$\mu A$	
<b>Error Amplifier</b>								
COMP Pin Sink Current	$I_{SINK}$	$V_{FB} = V_{REF} + 100mV$ , $V_{COMP} = 1.2V$	$+25^{\circ}C$		120		$\mu A$	
COMP Pin Source Current	$I_{SOURCE}$	$V_{FB} = V_{REF} - 100mV$ , $V_{COMP} = 1.2V$	$+25^{\circ}C$		18		$\mu A$	
High Clamp Voltage at the COMP Pin	$V_{CCLPH}$	$V_{FB} = 1.1V$ , $R_{ILIM} = 100k\Omega$	$+25^{\circ}C$		2		V	
Low Clamp Voltage at the COMP Pin	$V_{CCLPL}$	$V_{FB} = 1.3V$ , $R_{ILIM} = 100k\Omega$	$+25^{\circ}C$		0.4		V	
Error Amplifier Transconductance	$G_{EA}$	$V_{COMP} = 1.2V$	$+25^{\circ}C$		150		$\mu A/V$	
<b>Power Switch</b>								
High-side MOSFET On-Resistance	$R_{DS(ON)}$	$V_{CC} = 5V$	$+25^{\circ}C$		13	16.5	m $\Omega$	
Low-side MOSFET On-Resistance		$V_{CC} = 5V$	$+25^{\circ}C$		11	13.5	m $\Omega$	
<b>Current Limit</b>								
Switch Peak Current Limit	$I_{LIM}$	$R_{ILIM} = 100k\Omega$ , $V_{CC} = 5V$	$+25^{\circ}C$	9.3	11.3	13.4	A	
Reference Voltage at the ILIM Pin	$V_{ILIM}$		$+25^{\circ}C$		1.208		V	

**ELECTRICAL CHARACTERISTICS (continued)**

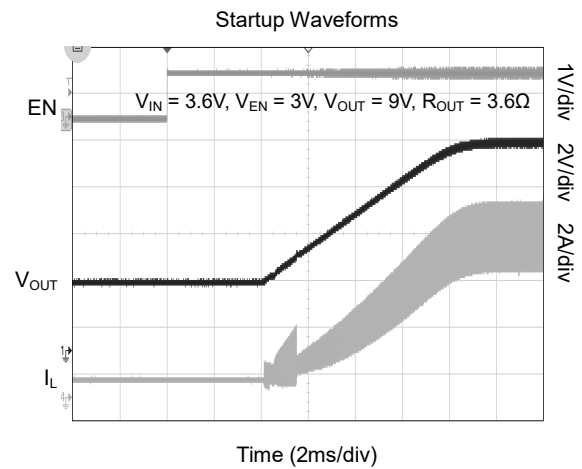
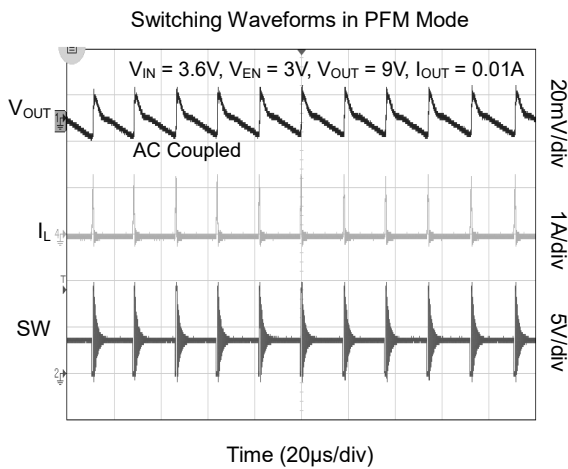
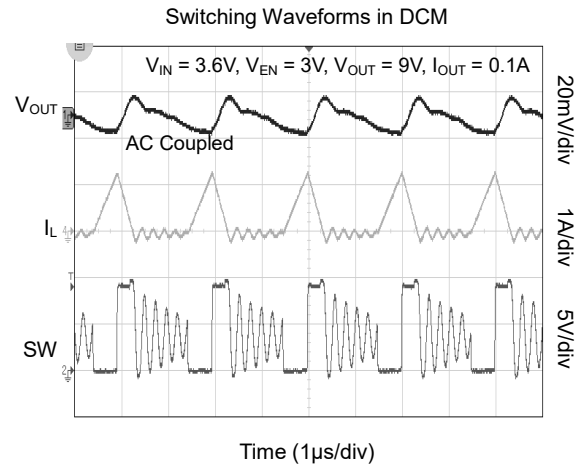
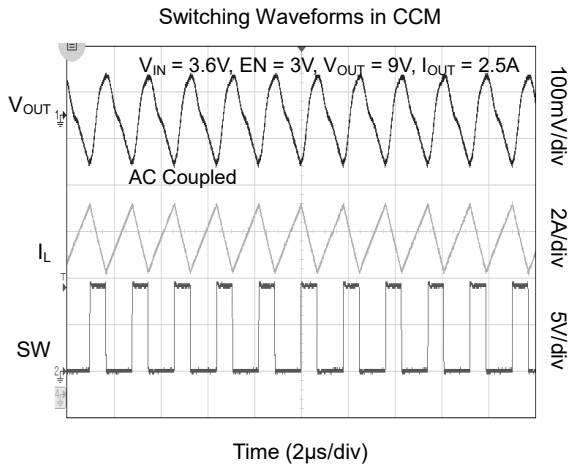
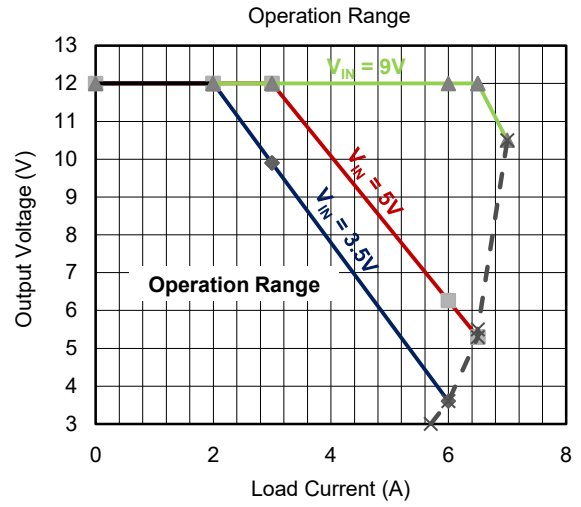
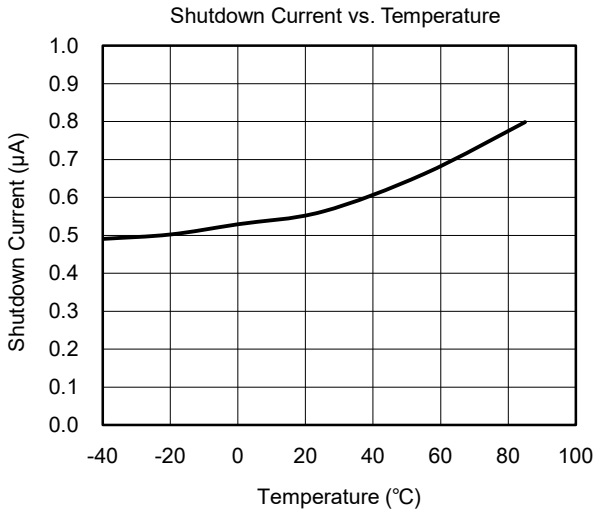
(Minimum and maximum values are at  $V_{IN} = 2.7V$  to  $5.5V$  and Full =  $-40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $V_{IN} = 3.6V$  and  $T_A = +25^{\circ}C$ .  $L = 1.2\mu H$ ,  $C_{OUT} = 47\mu F$ , unless otherwise specified noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
<b>Switching Frequency</b>							
Switching Frequency	$f_{SW}$	$R_{FREQ} = 301k\Omega$ , $V_{IN} = 3.6V$ , $V_{OUT} = 12V$	$+25^{\circ}C$		500		kHz
Minimum On-Time	$t_{ON\_MIN}$	$R_{FREQ} = 301k\Omega$ , $V_{IN} = 3.6V$ , $V_{OUT} = 12V$	$+25^{\circ}C$		120		ns
<b>Protection</b>							
Output Over-Voltage Protection Threshold	$V_{OVP}$	$V_{OUT}$ rising	Full	12.83	13.2	13.55	V
Output Over-Voltage Protection Hysteresis	$V_{OVP\_HYS}$	$V_{OUT}$ falling below $V_{OVP}$	$+25^{\circ}C$		0.15		V
<b>Thermal Shutdown</b>							
Thermal Shutdown Threshold	$T_{SD}$	$T_A$ rising			155		$^{\circ}C$
Thermal Shutdown Hysteresis	$T_{SD\_HYS}$	$T_A$ falling below $T_{SD}$			15		$^{\circ}C$

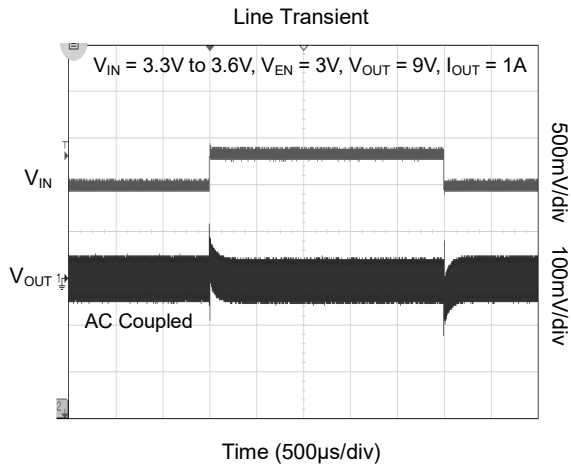
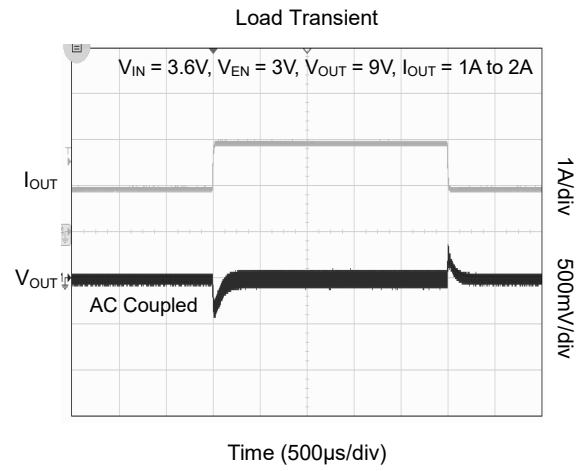
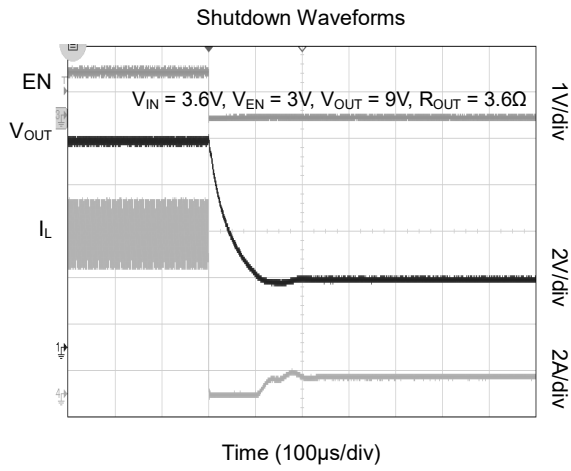
TYPICAL PERFORMANCE CHARACTERISTICS



TYPICAL PERFORMANCE CHARACTERISTICS (continued)



TYPICAL PERFORMANCE CHARACTERISTICS (continued)





PCB LAYOUT

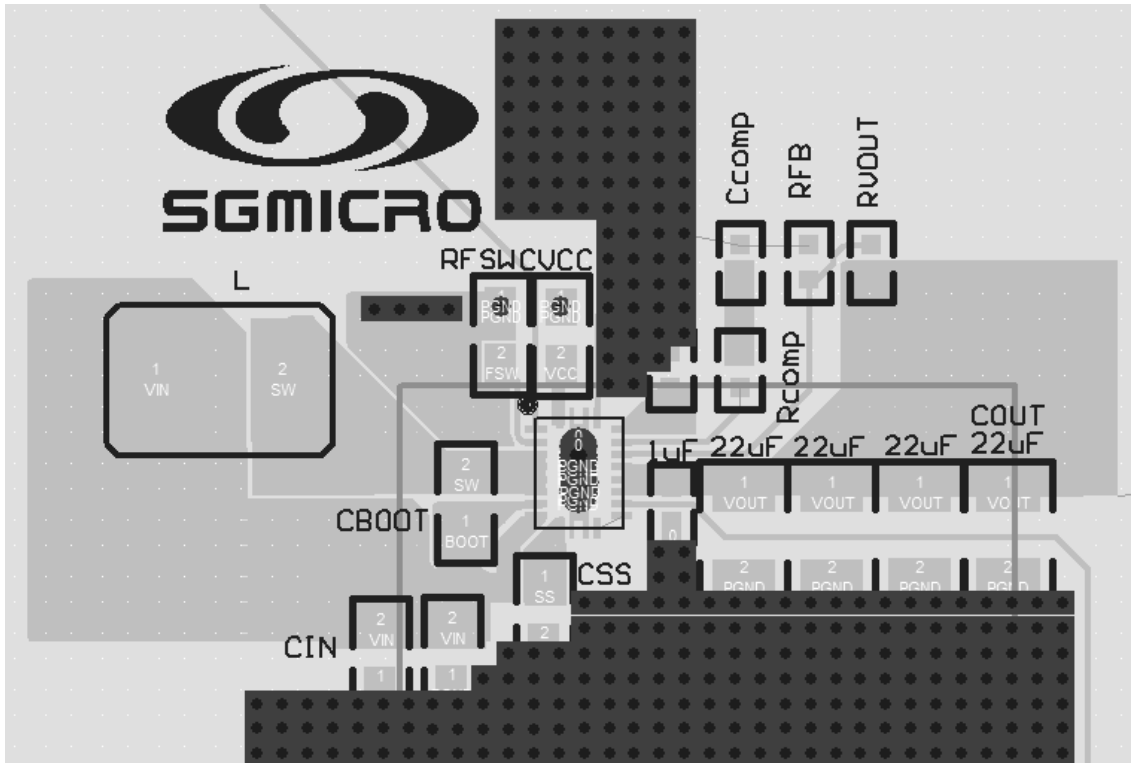


Figure 1. Top Layer

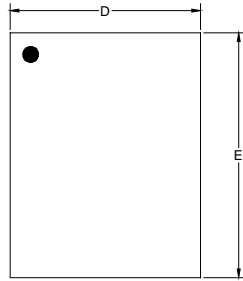
**REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

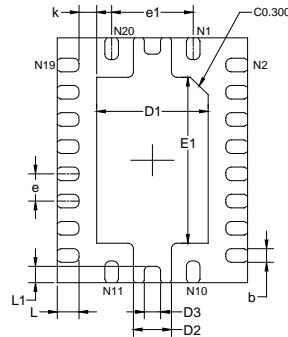
	<b>Page</b>
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<b>DECEMBER 2021 – REV.A.2 to REV.A.3</b>	
Updated the Typical Performance Characteristics section .....	6-8
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<b>OCTOBER 2021 – REV.A.1 to REV.A.2</b>	<b>Page</b>
Updated the Enable and Startup section.....	10
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<b>SEPTEMBER 2018 – REV.A to REV.A.1</b>	<b>Page</b>
Changed MODE pin to IC pin .....	All
<hr/>	
<b>Changes from Original (NOVEMBER 2017) to REV.A</b>	<b>Page</b>
Changed from product preview to production data.....	All
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PACKAGE OUTLINE DIMENSIONS

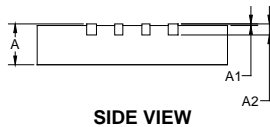
TQFN-4.5x3.5-20L



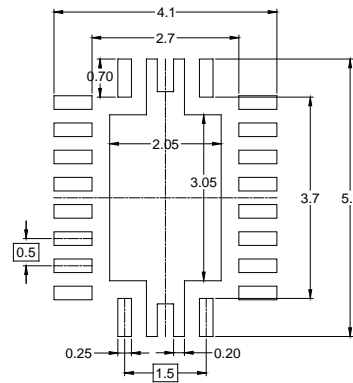
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 REF		0.008 REF	
D	3.400	3.600	0.134	0.142
D1	1.950	2.150	0.077	0.085
D2	0.650	0.850	0.026	0.033
D3	0.250	0.450	0.010	0.018
E	4.400	4.600	0.173	0.181
E1	2.950	3.150	0.116	0.124
k	0.325 REF		0.013 REF	
b	0.200	0.300	0.008	0.012
L	0.300	0.500	0.012	0.020
L1	0.224	0.376	0.009	0.015
e	0.500 BSC		0.020 BSC	
e1	1.500 BSC		0.060 BSC	

NOTE: This drawing is subject to change without notice.

# PACKAGE INFORMATION

## TAPE AND REEL INFORMATION

### REEL DIMENSIONS



### TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TQFN-4.5×3.5-20L	13"	12.4	3.75	4.75	0.95	4.0	8.0	2.0	12.0	Q1

DD0001

# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002

单击下面可查看定价，库存，交付和生命周期等信息

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